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Please record the attached original document(s) or copy(ies).

1. Name of conveying party(ies) and execution date:

Takaharu Hamada

Execution Date
Feb. 18, 2004

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: H & T Corporation

Street Address: 2-20-4 Morikawachi-Nishi, Higashi-Osaka

City: Osaka

Country: Japan

Zip: 577-0061

Additional name(s) address(es) attached?

☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Agreement/Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other:

37 CFR 1.8
CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to:
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T. Craine
Terri Craine

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application Number(s): 10/786,321

B. Patent Number(s):

Additional numbers attached: ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Wood, Phillips, Katz, Clark & Mortimer
Citicorp Center, Suite 3800
500 West Madison Street
Chicago, Illinois 60661-2511
Phone: (312) 876-1800

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41) \$ 40.00

- ☒ Enclosed
☐ Authorized to charge Deposit Account

8. Deposit Account No.: 23-0785

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9. SIGNATURE

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John S. Mortimer, 30,407

Name of Person Signing

John S. Mortimer
Signature

1/24/08

Date

Total number of pages including cover sheet, attachment, and documents: 3

AGREEMENT

This agreement is entered this 18th day of February, 2004 by and between Takaharu Hamada, an individual residing at 2-20-4 Morikawachi-Nishi, Higashi-Osaka, Osaka 577-0061 Japan (hereinafter "Assignor") and H & T Corporation, a corporation of Japan having a principal place of business at 2-20-4 Morikawachi-Nishi, Higashi-Osaka, Osaka 577-0061 Japan (hereinafter "Assignee").

WHEREAS, Assignor has made an invention, hereinafter identified as the "Safety Test Support System, Method and Program";

WHEREAS, the attached application for U.S. Letters Patent has been prepared on the Safety Test Support System, Method and Program (hereinafter "the U.S. Patent Application");

WHEREAS, Assignee is desirous of acquiring a percentage interest in and to the U.S. Patent Application and any patent or patents issuing therefrom (hereinafter "the Patent Rights);

NOW THEREFORE, for good and valuable consideration, the receipt and adequacy which are hereby acknowledged, Assignor does hereby sell, assign, transfer and set over to Assignee, an undivided one-tenth (1/10) of Assignor's right, title and interest in and to the Patent Rights, and including Assignor's right, title, and interest in and to any and all continuations, divisions, reissues, reexaminations, and extensions of the foregoing, which Assignor may have by operation of law or otherwise, and including the subject matter of all claims which may be obtained therefrom for Assignee's own use and enjoyment, and for the use and enjoyment of Assignee's successors, assigns, or other legal

PATENT

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